SN54136, SN54LS136, SN74136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE OR GATES WITH OPEN-COLLECTOR OUTPUTS

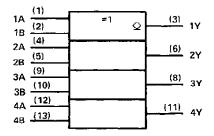
DECEMBER 1972 - REVISED MARCH 1988

UNCTI	ON	TABLE	

INP	UTS	OUTPUT
Α	8	Y
L	L	L
L	н	н
Н	L	н
Н	Н	L

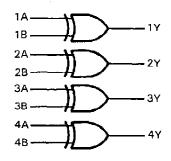
H = high level, L = low level

logic symbol†

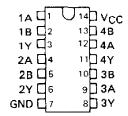


[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

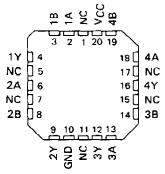
logic diagram (each gate)



SN54136, SN54LS136...J OR W PACKAGE SN74136...N PACKAGE SN74LS136...D OR N PACKAGE (TOP VIEW)



SN54LS136 . . . FK PACKAGE (TOP VIEW)

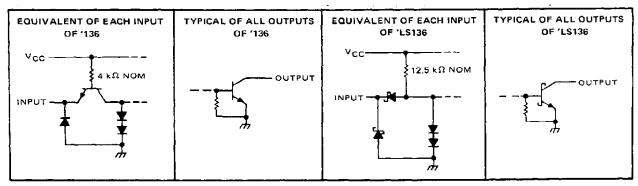


NC - No internal connection

positive logic

$$Y = A \oplus B = \overline{A} \cdot B + A \cdot \overline{B}$$

schematics of inputs and outputs



Resistor values shown are nominal.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard werranty. Production processing does not necessarily include testing of all parameters.



Pin numbers shown are for D, J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)														7	٧
Input voltage				-	-									5.5	V
Operating free-air temperature range:	SN54136										-5	5°0	C to	125	,C
	SN74136														
Storage temperature range														150	

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5413		SN74136				
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧	
High-level input voltage, VIH	2			2			٧	
Low-level input voltage, VIL			Q.B			0.8	V	
High-level output voltage, VOH			5.5			5.5	V	
Low-level output current, IOL			16			16	mA	
Operating free-air temperature, TA	- 55	-	125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN5413	6	,	6	UNIT		
PANAIVIETEN		. 1231 6	ONDITIONS.		MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK_	V _{CC} = MIN,	l ₁ = -8 mA					- 1.5			- 1.5	V
la	VCC = MIN,	$V_{1H} = 2 V_{r}$	$V_{\rm IL} = 0.8 V_{\rm s}$	V _{OH} = 5.5 V	-					0.25	mΑ
Іон	$V_{CC} = MIN,$	V _{IH} = 2 V.	$V_{\rm IL} = 0.7 \rm V_{\rm c}$	V _{OH} = 5.5 V			0.25				ША
VOL	$V_{CC} = MIN,$	$V_{1H} = 2 V_{i}$	$V_{\rm IL} = 0.8 \rm V$,	1 _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
l _l	$V_{CC} = MAX$,	V _I = 5.5 V					. 1			1	mΑ
li li	VCC = MAX,	$V_1 = 2.4 \text{ V}$					40			40	μΑ
կլ_	$V_{CC} = MAX$,	V _[= 0.4 V					-1.6			- 1.6	mΑ
	V _{CC} = MAX,	See Note 2				30	43		30	50	mA

 $^{^{\}dagger}$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

NOTE 2: I_{CC} is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST CO	NOITIONS	MIN	TYP	MAX	UNIT
tPLH .	A ne P	Oshou in our law	5 45 5		12	18	
tPHL	A or B	Other input low	C _L = 15 pF, R _L = 400 Ω,		39	50	ns
tPLH.	A or B	Oshaniaans biab	i -		14	22	ns
tpHL	A or B	Other input high	See Note 3		42	55] "

¹tpLH propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

tplH propagation delay time, high-to-low-level output

SN54LS136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES WITH OPEN-COLLECTOR OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)														7 V
Input voltage														
Operating free-air temperature range	: SN54LS136		_		_	 					~5	5°0	to:	125°C
•	SN74LS136								_			0°	C t	ი 70°C
Storage temperature range														

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	12	154LS1	36	SI	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	CIVIT
Supply voltage, V _{CC}	4,5	5	5.5	4.75	5	5.25	٧
High-level output voltage, V _{OH}			5.5			5.5	٧
Low-level output current, IOL			4			8	mΑ
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAGAMETER	7507.001	SI	N54LS1	36	SI				
PARAMETER	TEST CON	IDITIONS	MIN	TYP#	MAX	MIN	TYP#	MAX	UNIT
VIH High-level input voltage			2			2			٧
VIL Low-level input voltage					0.7			0.8	V
VIK Input clamp voltage	VCC = MIN.	l ₁ = -18 mA	1		-1.5			-1.5	٧
IOH High-level output current	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{OH} = 5.5 V			100			100	μА
VOL Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4	_	0.25	0.4	V
	VIL = VIL max	IQL = 8 mA					0.35	0.5	
I Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V			0.2			0.2	mΑ
I _{IH} High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V			40			40	μА
ILL Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V	_		-0.8	l —		-0.8	mΑ
ICC Supply current	V _{CC} = MAX,	See Note 2	1	6.1	10		6.1	10	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

NOTE 2: ICC is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TEST CO	NDITIONS	MIN	ТҮР	MAX	UNIT
tpLH	A or B	Other input low	0 - 15 - 5		18	30	ns
tPHL		Other triput 1000	Cլ=15 pF, Rլ=2 kΩ,		18	30	
tPLH	A or B	Other input high	(See Note 3)		18	30	ns
^t PHL		Other input high	(366 140(8.3)		18	30	

¹tpLH propagation delay time, low-to-high-level output

tp[H propagation delay time, high-to-low-level output NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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